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(54) **ANTISTATIC CONDUCTIVE GRID PATTERN WITH INTEGRAL LOGO**

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(58) **Field of Classification Search** ..... **428/195.1, 428/323, 423.1, 480, 500, 172**  
See application file for complete search history.

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(57) **ABSTRACT**

The present invention relates to an article comprising a substrate having thereon at least one antistatic layer, wherein said antistatic layer comprises at least one conductive material, and wherein said antistatic layer comprises areas of patterned coverage, and wherein said patterned coverage comprises a graphic design.

**126 Claims, 4 Drawing Sheets**

